

## STGW30NB60H

### N-CHANNEL 30A - 600V TO-247 PowerMESH<sup>TM</sup> IGBT

TYPE	Vces	V <sub>CE(sat)</sub>	Ι <sub>C</sub>
STGW30NB60H	600 V	< 2.8 V	30 A

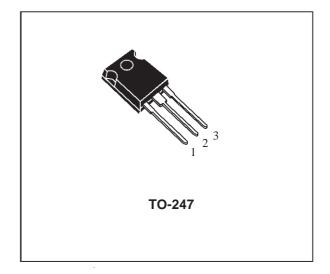
- HIGH INPUT IMPEDANCE (VOLTAGE DDIV(EN))
- (VOLTAGE DRIVEN)
- LOW ON-VOLTAGE DROP (VCESAT)
- LOW GATE CHARGE
- HIGH CURRENT CAPABILITY
- VERY HIGH FREQUENCY OPERATION
- OFF LOSSES INCLUDE TAIL CURRENT

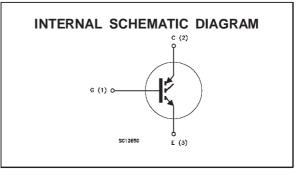
#### DESCRIPTION

Using the latest high voltage technology based on a patented strip layout, STMicroelectronics has designed an advanced family of IGBTs, the PowerMESH<sup>TM</sup> IGBTs, with outstanding perfomances. The suffix "H" identifies a family optimized to achieve very low switching times for high frequency applications (<120kHz).

#### **APPLICATIONS**

- HIGH FREQUENCY MOTOR CONTROLS
- WELDING EQUIPMENTS
- SMPS AND PFC IN BOTH HARD SWITCH AND RESONANT TOPOLOGIES





Symbol	Parameter	Value	Unit
V <sub>CES</sub>	Collector-Emitter Voltage (V <sub>GS</sub> = 0)	600	V
V <sub>ECR</sub>	Emitter-Collector Voltage	20	V
V <sub>GE</sub>	Gate-Emitter Voltage	± 20	V
lc	Collector Current (continuous) at $T_c = 25$ °C	60	A
lc	Collector Current (continuous) at $T_c = 100$ °C	30	A
I <sub>CM</sub> (•)	Collector Current (pulsed)	240	A
P <sub>tot</sub>	Total Dissipation at $T_c = 25$ °C	190	W
	Derating Factor	1.52	W/ºC
Tstg	Storage Temperature	-65 to 150	°C
Tj	Max. Operating Junction Temperature	150	°C

#### ABSOLUTE MAXIMUM RATINGS

(•) Pulse width limited by safe operating area

#### THERMAL DATA

ſ	R <sub>thj-case</sub>	Thermal	Resistance	Junction-case	Max	0.66	°C/W
	R <sub>thj-amb</sub>	Thermal	Resistance	Junction-ambient	Max	30	oC/W
	R <sub>thc-h</sub>	Thermal	Resistance	Case-heatsink	Тур	0.1	°C/W

# **ELECTRICAL CHARACTERISTICS** (T<sub>j</sub> = 25 $^{\circ}$ C unless otherwise specified) OFF

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V <sub>BR(CES)</sub>	Collector-Emitter Breakdown Voltage	$I_{C} = 250 \ \mu A$ $V_{GE} = 0$	600			V
I <sub>CES</sub>	Collector cut-off $(V_{GE} = 0)$				10 100	μΑ μΑ
I <sub>GES</sub>	Gate-Emitter Leakage Current (V <sub>CE</sub> = 0)	$V_{GE} = \pm 20 \text{ V} \qquad V_{CE} = 0$			± 100	nA

#### **ON (**\*)

Symbol	Parameter	Test Conditions		Тур.	Max.	Unit
$V_{GE(th)}$	Gate Threshold Voltage	$V_{CE} = V_{GE}$ I <sub>C</sub> = 250 µA	3		5	V
V <sub>CE(SAT)</sub>	Collector-Emitter Saturation Voltage	$ \begin{array}{lll} V_{GE} = \ 15 \ V & I_C = \ 30 \ A \\ V_{GE} = \ 15 \ V & I_C = \ 30 \ A & T_j = \ 125 \ ^oC \end{array} $		2.2 1.8	2.8	V V

#### DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
gfs	Forward Transconductance	V <sub>CE</sub> =25 V I <sub>C</sub> = 30 A		20		S
C <sub>ies</sub> C <sub>oes</sub> C <sub>res</sub>	Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{CE} = 25 V$ f = 1 MHz $V_{GE} = 0$		2300 250 60		pF pF pF
Q <sub>G</sub> Q <sub>GE</sub> Q <sub>GC</sub>	Total Gate Charge Gate-Emitter Charge Gate-Collector Charge	$V_{CE} = 480 \text{ V}$ $I_{C} = 30 \text{ A}$ $V_{GE} = 15 \text{ V}$		150 15 72		nC nC nC
I <sub>CL</sub>	Latching Current		120			A

#### SWITCHING ON

Symbol	Parameter	Test Con	ditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub> t <sub>r</sub>	Delay Time Rise Time	V <sub>CC</sub> = 480 V V <sub>GE</sub> = 15 V	$I_{C} = 30 \text{ A}$ $R_{G} = 10\Omega$		15 75		ns ns
(di/dt) <sub>on</sub>	Turn-on Current Slope	V <sub>CC</sub> = 480 V R <sub>G</sub> = 10 Ω	I <sub>C</sub> = 30 A V <sub>GE</sub> = 15 V		760		A/µs
Eon	Turn-on Switching Losses	T <sub>j</sub> = 125 °C			850		μJ

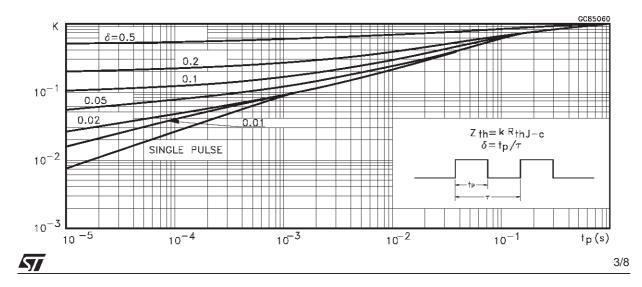
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#### ELECTRICAL CHARACTERISTICS (continued) SWITCHING OFF

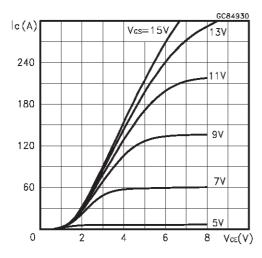
Symbol	Parameter	Test Condition	ons	Min.	Тур.	Max.	Unit
$\begin{array}{c} t_c \\ t_r(v_{off}) \\ t_d(off) \\ t_f \\ E_{off}(^{**}) \\ E_{ts} \end{array}$	Cross-Over Time Off Voltage Rise Time Delay Time Fall Time Turn-off Switching Loss Total Switching Loss	$V_{CC} = 480 V$ $R_{GE} = 10 \Omega$	I <sub>C</sub> = 30 A V <sub>GE</sub> = 15 V		150 40 210 90 1.10 1.8		ns ns ns mJ mJ
$\begin{array}{c} t_c \\ t_r(v_{off}) \\ t_d(o_{ff}) \\ t_f \\ E_{off}(^{**}) \\ E_{ts} \end{array}$	Cross-Over Time Off Voltage Rise Time Delay Time Fall Time Turn-off Switching Loss Total Switching Loss	VCC = 480 V R <sub>GE</sub> = 10 Ω T <sub>j</sub> = 125 °C	I <sub>C</sub> = 30 A V <sub>GE</sub> = 15 V		250 70 250 160 1.6 2.45		ns ns ns mJ mJ

(•) Pulse width limited by max. junction temperature
(\*) Pulsed: Pulse duration = 300 μs, duty cycle 1.5 %
(\*\*)Losses Include Also The Tail (Jedec Standardization)

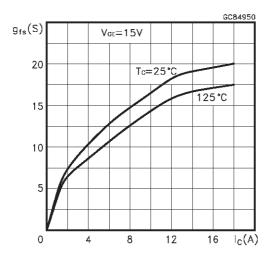
#### Thermal Impedance



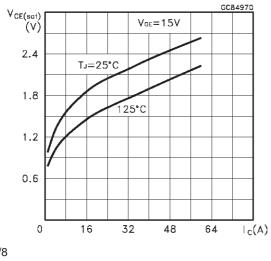
#### **Output Characteristics**



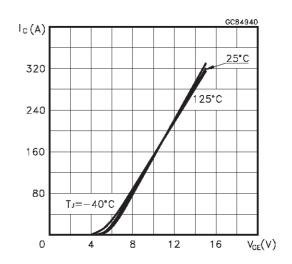
Transconductance



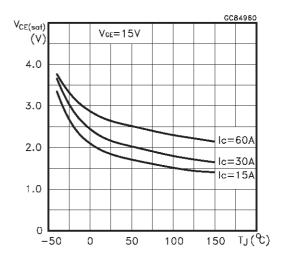
Collector-Emitter On Voltage vs Collector Current

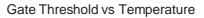


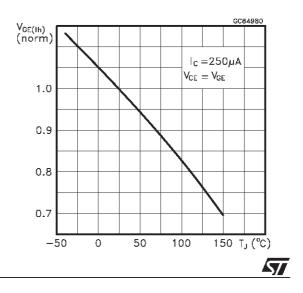
**Transfer Characteristics** 

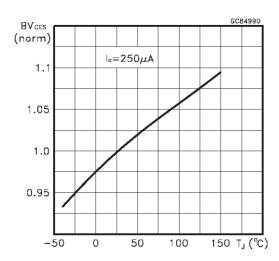


Collector-Emitter On Voltage vs Temperature



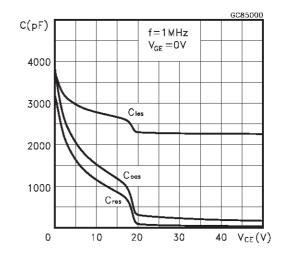




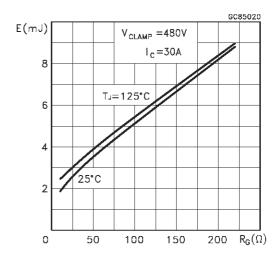


#### Normalized Breakdown Voltage vs Temperature

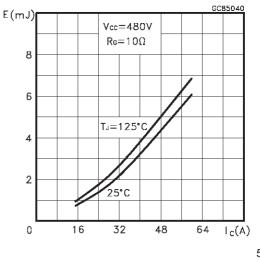
**Capacitance Variations** 



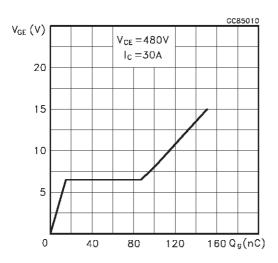
Total Switching Losses vs Gate Resistance



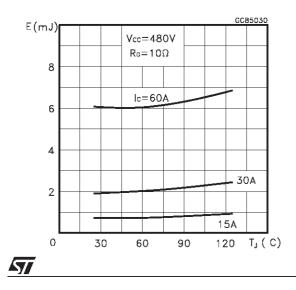
Total Switching Losses vs Collector Current







Total Switching Losses vs Temperature





Switching Off Safe Operating Area

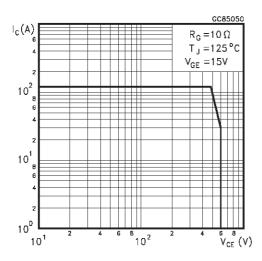
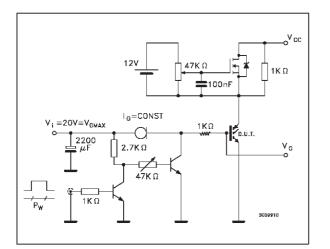


Fig. 1: Gate Charge test Circuit



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Fig. 2: Test Circuit For Inductive Load Switching

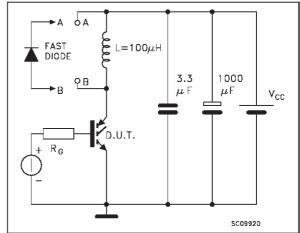
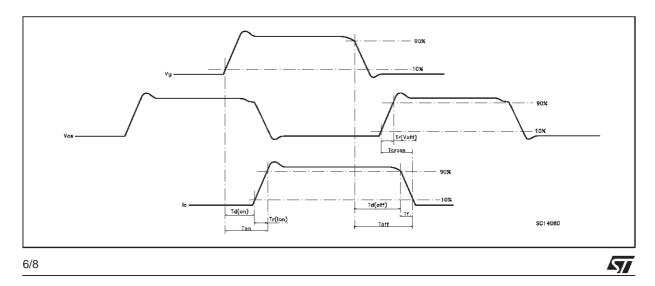
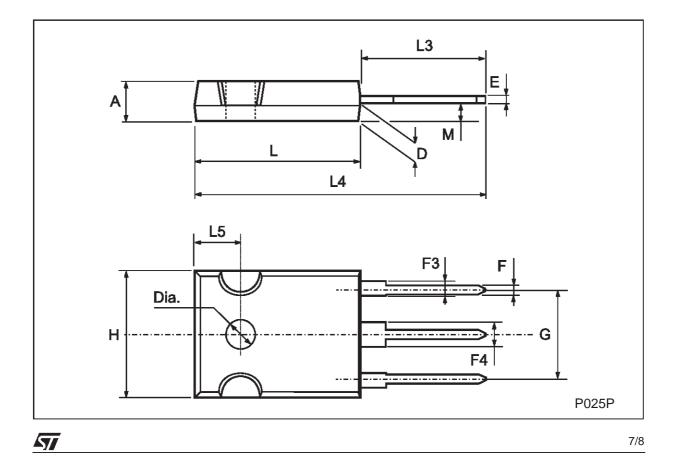


Fig. 3 Switching Waveforms



DIM.		mm			inch	
DIWI.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	4.7		5.3	0.185		0.209
D	2.2		2.6	0.087		0.102
E	0.4		0.8	0.016		0.031
F	1		1.4	0.039		0.055
F3	2		2.4	0.079		0.094
F4	3		3.4	0.118		0.134
G		10.9			0.429	
Н	15.3		15.9	0.602		0.626
L	19.7		20.3	0.776		0.779
L3	14.2		14.8	0.559		0.582
L4		34.6			1.362	
L5		5.5			0.217	
М	2		3	0.079		0.118





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